

SBR3M30P1

3.0A SBR[®] Surface Mount Super Barrier Rectifier PowerDI™123

Features Mechanical Data

- Ultra Low Leakage Current
- Excellent High Temperature Stability
- Superior Reverse Avalanche Capability
- Patented Interlocking Clip Design for High Surge Current Capacity
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- 175°C Operating Junction Temperature
- ±16KV ESD Protection (HBM, 3B)
- ±25KV ESD Protection (IEC61000-4-2 Level 4, Air Discharge)
- Lead Free Finish, RoHS Compliant (Note 1)
- "Green" Molding Compound (No Br, Sb)
- Qualified to AEC-Q 101 Standards for High Reliability

- Case: PowerDI™123
- Case Material: Molded Plastic, "Green" Molding compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- · Polarity Indicator: Cathode Band
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Marking Information: See Page 4
- Ordering Information: See Page 4

Maximum Ratings @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	30	V
RMS Reverse Voltage	V _{R(RMS)}	21	V
Average Rectified Output Current (See Figure 1)	lo	3.0	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	75	А
Non-Repetitive Avalanche Energy $(T_J = 25^{\circ}C, I_{AS} = 5A, L = 8.5 \text{ mH})$	E _{AS}	105	mJ
Repetitive Peak Avalanche Energy (1µs, 25°C)	P _{ARM}	1100	W
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 2) Thermal Resistance Junction to Ambient (Note 3) Thermal Resistance Junction to Ambient (Note 4)	R _{OJS} R _{OJA}	5 183 125	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175	°C

Notes:

- 1. RoHS revision 13.2.2003. High temperature solder exemption applied, see *EU Directive Annex Note* 7.
- 2. Theoretical $R_{\Theta JS}$ calculated from the top center of the die straight down to the PCB cathode tab solder junction.
- 3. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf.
- 4. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/datasheets/ap02001.pdf

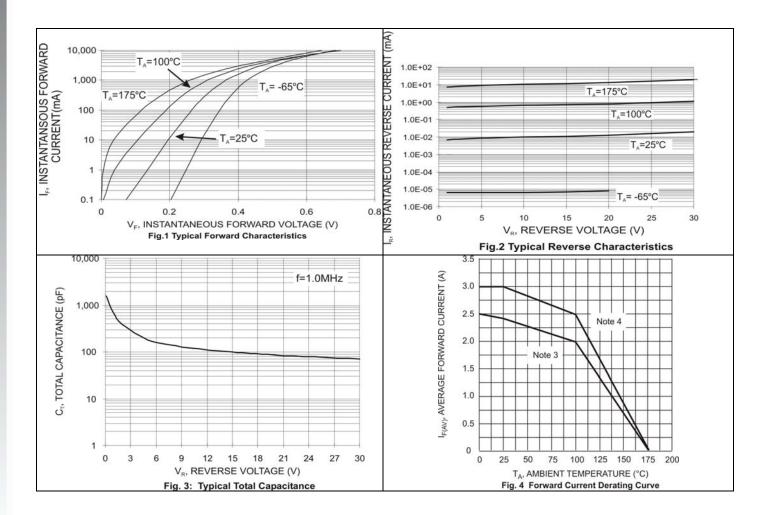


Electrical Characteristics @ T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	$V_{(BR)R}$	30	-	-	V	Ι _R = 250 μΑ
Forward Voltage Drop	V _F	- - - -	0.26 0.37 0.46 0.16 0.29 0.42	0.30 0.41 0.50 0.19 0.32 0.45	V	$I_F = 0.1A, T_J = 25^{\circ}C$ $I_F = 1.0A, T_J = 25^{\circ}C$ $I_F = 3.0A, T_J = 25^{\circ}C$ $I_F = 0.1A, T_J = 125^{\circ}C$ $I_F = 1.0A, T_J = 125^{\circ}C$ $I_F = 3.0A, T_J = 125^{\circ}C$
Leakage Current (Note 5)	I _R	-	8.5 19 1.7 3.1	100 200 15 20	μΑ μΑ mA mA	$V_R = 5V, T_J = 25 {}^{\circ}\text{C}$ $V_R = 30V, T_J = 25 {}^{\circ}\text{C}$ $V_R = 5V, T_J = 125 {}^{\circ}\text{C}$ $V_R = 30V, T_J = 125 {}^{\circ}\text{C}$

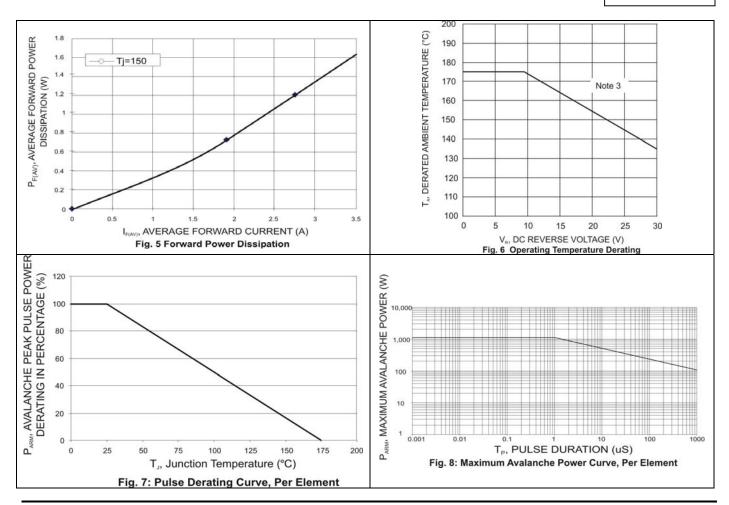
Notes:

5. Short duration pulse test used to minimize self-heating effect.

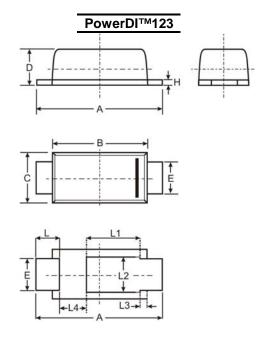




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Package Outline Drawings



PowerDI [™] 123									
Dim	Min	Max	Тур						
Α	3.65	3.75	3.70						
В	2.775	2.825	2.80						
С	1.750	1.800	1.775						
D	0.955	1.000	0.98						
E	0.95	1.05	1.00						
H 0.15		0.25	0.20						
L	L 0.60		0.65						
L1		_	1.36						
L2	_	_	1.10						
L3	_	_	0.20						
L4	0.95	1.25	1.05						
All Dimensions in mm									



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Marking, Polarity, Weight & Ordering Information

	Case	Style	Marking	Weight		
SBR3M30P	Top View Back View		[]3M3 ≥	0.096g (approx.)		

Ordering Information	Date Code				
SBR3M30P1-7 3000/Tape & Reel	3M3 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)				

Date Code Key

Year	2006		2007		2008		2009		2010	2	2011	20)12	
Code	Т		U		V		W		Х		Y		Z	
N	Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec	
	Code	1	2	3	4	5	6	7	8	9	0	N	D	

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